

System Performance Booklet



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System Overview

Description	Model			S	erial Number	
CCD Head	D U 9	34P -	BR-DD	С	CD-16343	
TE Cooler performance (~)		Н	igh	Ultra-high	•
Accessories	Power Su	upply Unit (P	S -24)		PS -25	
					~	
	SO-	LM-		MFL-		
Serial/Batch Number						
Other						

[∇] Sensor types are defined in Table 1 using the last two letters in box Model Number.

CCD Details

Manufac	turer / Model No.	Pixels	Serial Number
E2V	CCD47-10	1024x1024, 13μm x 13μm	10141-09-13
E2V	CCD57-10	512x512, (FT), 13μm x 13μm	
E2V	CCD77-00	512x512, 24μm x 24μm	

Special Feature	(~)		(•)
NIMO	~	AR coated Window (1/2° wedge)	
Fringe Suppression	Y	Custom Cables	
Shielded Anti-Blooming		Custom Mounting Flange	
MgF ₂ Input			

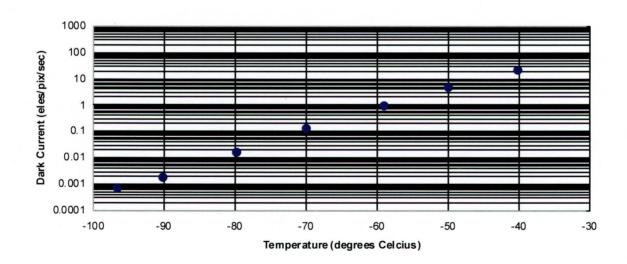


Summary of System Test Data

Readout Noise *1 and Base Mean Level

A/D Rate	Preamp	CCD	Single Pixel	Full Vert Bin	Base Level ≠2
(MHz All 16 bit)	setting	Sensitivity ◆3	Noise	Noise	(Counts)
7 til 10 bit)	eles per A/D count electrons electrons				
5	x1	6.5	34.3	35.8	1059
5	x2	3.1	18.3	19.0	1642
5	x4	1.6	13.9	14.4	2911
3	x1	5.8	19.2	19.5	1098
3	x2	2.9	12.7	13.2	2070
3	x4	1.3	10.3	11.0	3697
1	x1	5.3	11.4	11.1	902
1	x2	2.7	8.1	8.0	1818
1	x4	1.2	6.8	6.8	3697
0.05	x1	5.2	5.3	5.3	526
0.05	x2	2.7	4.4	4.5	1429
0.05	x4	1.2	3.7	3.8	3280
Satura	tion Signal p	er pixel	129050	Electror	ns/pixel

CCD Dark Current



Minimum Dark Current Achievable ◆4	0.000717	electr	ons/pixel	/sec
@ Sensor Temperature of ◆5	-96.77	°C	16	°C cooling Water
		With P	S-25	
CCD Dark Current Uniformity better than ◆6	0.43803	electr	ons/pixel	/sec



Linearity and Uniformity

Linearity better than ◆7	1	% over 16 bits
Response Uniformity better than ◆8	2.18	%

Response Defects

W	hite/E	Black	Spot	s •9	Э			(X,Y
	C	entro	id		Number of Pixels	Centroid	1	Number of Pixels
(Χ	,	Χ)	X	(,)	
(Х	,	Χ)	X	(, ,)	
(,	***************************************)		,)	
(,)		(,)	
(,)		,)	
(,)		, ,))	
	hite/E				Column num	bers indicated	X	X
Co	olumi	1S ♦ 1	U				X	X
Tr	ap +	11				(X,Y)	(X	, X)

Dark Current Defects

Н	ot S _l	t Spots ◆12 (X,Y)					
	C	entro	oid		Number of Pixels	Centroid	Number of Pixels
(Х	,	Х)	X	()
(X	,	X)	X	()
(,)		,)
(***************************************	,	***************************************)		,	
(,)		,)
н	ot C	olur	nns	◆ 13	Column num	bers indicated	X



Test Conditions

Readout Noise tested at	-80	°C with	16	°C water
Base Mean Level measured at	-80	°C with	16	°C water
Dark Current Uniformity tested at	-65	°C with	16	°C water
Blemishes tested at	-65	°C with	16	°C water

Custom Testing

Signed System Passed for Shipping
Date

G. McCullough

27TH JANUARY 2014

Hardware HEADBOARD FPGA
Version # AB 20.24

Shipping Software

e solis sdi

Version # -- 2.96.30004.0

Testing

Number

Software _{SOLIS} SDK

Version # 4.24..30004.0 2.96.30004.0

∇ Table 1; Key code to define the meanings of the last two letters in the Model

Sensor Options					
OE	Open electrode	BU2	Back Illuminated (BI) + 250nm UV optimised		
FI	Front illuminated (FI)	BU	BI + UV (350nm) optimised		
UV	FI+UV coating	BV	BI + VIS (550nm) optimised)		
FO	FI + Fibre optic	BR-DD	BI + NIR +deepdepletion		
FI-DD	FI + deep depletion	BN	BI with no AR coating		



Performance Notes

- Readout Noise is measured for both single pixel (SP) and fully vertically binned (FVB) with the CCD in darkness at temperature indicated and minimum exposure time. Noise values will change with pre-amplifier gain selection [PAG].
- ♠2 Average electronic DC offset for CCD in darkness at temperature indicated and minimum exposure time under dark conditions measured by single pixel (SP) for imaging systems and by (FVB) for spectroscopic systems.
- Sensitivity is calculated in photoelectrons per A/D count from measurements of the Photon Transfer Curve.
- Dark current falls exponentially with temperature. However, for a given temperature the actual dark current can vary by more than an order of magnitude from device to device. The devices are specified in terms of minimum dark current achievable rather than minimum temperature.
- ◆5 Minimum temperature achieved for thermoelectric (TE) cooler set to maximum value with water cooling
- RMS (root mean square) deviation of dark current for fully binned operation for spectroscopic cameras, or full resolution image for imaging cameras, under dark conditions at temperature indicated (pixel/column defects not included). This variation is mainly cosmetic since it is fully subtractable without significant loss of performance.
- ◆7 Linearity is measured from a plot of Counts vs. Signal over the 16 bit dynamic range. Linearity is expressed as a %age deviation from a straight line fit. This quantity is not measured on individual systems.
- ♠8 RMS (root mean square) deviation from the average response of the CCD in full resolution image for imaging cameras, illuminated with uniform white light (defects not included).
- ♦9 White/black pixels have signals >25% above/below the average (25% contrast) with uniform illumination across the sensor.
- ◆10 A black column is defined as having ≥ 10 black pixels for imaging cameras.
- ◆11 Pixels which absorb charge as it is clocked through the defective area. When the light source is switched off, the signal from the trap appears to drop off more slowly than the signal from the surrounding pixels.
- ♦12 Hot spots are counted if they exhibit >50 times the maximum specified dark current at the test temperature indicated.
- ◆13 A column is considered defective if >10 pixels are affected, or if the column exhibits
 >2 times the maximum specified dark current at the test temperature indicated.